

Title (en)  
HERMETIC ENCAPSULATION OF ORGANIC ELECTRO-OPTICAL ELEMENTS

Title (de)  
HERMETISCHE VERKAPSELUNG VON ORGANISCHEN ELEKTRO-OPTISCHEN ELEMENTEN

Title (fr)  
ENCAPSULAGE HERMETIQUE D'ELEMENTS ELECTRO-OPTIQUES ORGANIQUES

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Application  
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Abstract (en)  
[origin: WO03088370A2] The invention relates to a hermetic encapsulation of organic electro-optical elements. The aim of the invention is to improve the service life of the aforementioned organic, opto-electronic elements. The invention provides a method for producing said elements which comprises the steps of: providing a support (3), applying a first conductive layer (13), applying at least one layer (15) that comprises at least one organic, electro-optical material, applying a second conductive layer (17), and depositing at least one layer (7, 71, 72,..., 7N) having a glass-like structure.

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